## IN THE CLAIMS:

Please cancel claims 17-22 without prejudice to or disclaimer of the subject matter recited therein.

Please add new claims 23-28 as follows.

## LISTING OF CURRENT CLAIMS

Claim 1. (Previously Presented) A liquid crystal display comprising:

- a liquid crystal display panel;
- a plastic frame, supporting said liquid crystal display panel;
- a metal cover, boxing said plastic frame therein and forming an interior space to accommodate said liquid crystal display panel;
- a print circuit board, fixed on a lower surface of said plastic frame and connecting to said liquid crystal display panel by a flexible flat cable extending along a sidewall of said plastic frame:
- a passivation film, taped on a lower surface of said print circuit board as an electric shielding and extending further to cover the flexible flat cable; and
- a conductive film, formed on a grounding pin of said print circuit board and another sidewall of said metal cover for transmitting segregated charges on said print circuit board through said metal cover to environment.

Claims 2-3. (Canceled)

Claim 4. (Original) The liquid crystal display of claim 1, wherein said conductive film is taped on the grounding pin and said metal cover by gluing.

Claim 5. (Previously Presented) The liquid crystal display of claim 1, wherein said conductive film is a conductive tape with both surfaces gluey, in which one surface of said conductive tape is taped on the grounding pin of said print circuit board and the sidewall of said metal cover and the other surface is used to glue the passivation film on a lower surface of said print circuit board to form an electric shielding upon devices on said print circuit board.

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Claim 6. (Original) The liquid crystal display of claim 1, wherein said print circuit board connects to said liquid crystal display panel through the flexible flat cable and attends with connecting devices such as tape automated bounding (TAB), chip on glass (COG), or chip on film (COF).

Claim 7. (Original) The liquid crystal display of claim 1, wherein said two grounding pins are formed at opposite edges of said print circuit board without connecting flexible flat cables.

Claim 8. (Original) The liquid crystal display of claim 1, wherein the grounding pin is form on a lower surface of said print circuit board.

Claim 9. (Original) The liquid crystal display of claim 1, wherein the grounding pin extends from an edge of said print circuit board to the outside.

Claim 10. (Original) The liquid crystal display of claim 1, wherein said conductive film is taped around said print circuit board.

Claim 11. (Original) A print circuit board assembled in a liquid crystal display and utilized to control displaying signals, comprising:

a plurality of flexible flat cables, extending from an edge of the print circuit board to a liquid crystal display panel;

a grounding pin, formed on the print circuit board;

a passivation film, covering an exposed surface of the print circuit board as an electric shielding; and

a conductive film, taped on both said grounding pin and a metal cover of the liquid crystal display to transport segregated charges on the print circuit board to environment, and taped along the edges of the print circuit board to fix said passivation film.

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Claim 12. (Original) The print circuit board of claim 11, wherein said grounding pin is formed on an edge of the print circuit board without connecting flexible flat cables.

Claim 13. (Original) The print circuit board of claim 11, wherein said grounding pin is formed on the exposed surface of the print circuit board and close to an edge of the print circuit board.

Claim 14. (Original) The print circuit board of claim 11, wherein said grounding pin is extended from an edge of the print circuit board to outside the print circuit board.

Claim 15. (Original) The print circuit board of claim 11, wherein said conductive film is a conductive tape with both surfaces gluey, in which one surface of said conductive tape is taped on said grounding pin and sidewalls of the metal cover and the other surface is used to glue said passivation film on a lower surface of the print circuit board to form an electric shielding upon devices on the print circuit board.

Claim 16. (Original) The print circuit board of claim 11, wherein the print circuit board connects to the liquid crystal display panel through said flexible flat cable.

Claims 17-22. (Canceled)

23. (New) A liquid crystal display comprising:

a liquid crystal display panel;

a plastic frame, supporting said liquid crystal display panel;

a metal cover, boxing said plastic frame therein and forming an interior space to accommodate said liquid crystal display panel; a print circuit board, fixed on a lower surface of said plastic frame and connecting to said liquid crystal display panel by a flexible flat cable extending along a sidewall of said plastic frame; and

a conductive film, formed on a grounding pin of said print circuit board and another sidewall of said metal cover for transmitting segregated charges on said print circuit board through said metal cover to environment;

wherein a surface area of the conductive film being substantially smaller than that of the printed circuit board.

- 24. (New) The liquid crystal display of claim 23, wherein said conductive film is taped on the grounding pin and said metal cover by gluing.
- 25. (New) The liquid crystal display of claim 23, wherein said conductive film is a conductive tape with both surfaces gluey, in which one surface of said conductive tape is taped on the grounding pin of said print circuit board and the sidewall of said metal cover and the other surface is used to glue a passivation film on a lower surface of said print circuit board to form an electric shielding upon devices on said print circuit board.
- 26. (New) The liquid crystal display of claim 23, wherein said two grounding pins are formed at opposite edges of said print circuit board without connecting flexible flat cables.
- 27. (New) The liquid crystal display of claim 23, wherein the grounding pin is form on a lower surface of said print circuit board.
- 28. (New) The liquid crystal display of claim 23, wherein said conductive film is taped around said print circuit board.